

^{OGY} Low Noise, 8th Order, Clock Sweepable Cauer Lowpass Filter

FEATURES

- 8th Order Filter in a 14-Pin Package
- 80dB or More Stopband Attenuation at 2 × f_{CUTOFF}
- 50:1, f_{CLK} to f_{CUTOFF} Ratio (Cauer) 100:1, f_{CLK} to f_{-3dB} Ratio (Transitional)
- 135µV_{RMS} Total Wideband Noise
- 0.03% THD or Better
- 100kHz Maximum f_{CUTOFF} Frequency
- Operates up to ±8V Power Supplies
- Input Frequency Range up to 50 Times the Filter Cutoff Frequency

APPLICATIONS

- Antialiasing Filters
- Telecom Filters
- Sinewave Generators

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DESCRIPTION

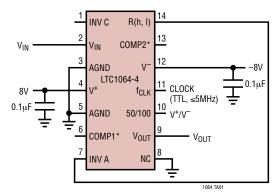
The LTC®1064-4 is an 8th order, clock sweepable Cauer lowpass switched capacitor filter. An external TTL or CMOS clock programs the value of the filter's cutoff frequency. With Pin 10 at V+, the f_{CLK} to f_{CUTOFF} ratio is 50:1; the filter has a Cauer response and with compensation the passband ripple is $\pm 0.1 dB$. The stopband attenuation is 80dB at 2 \times f_{CUTOFF} . Cutoff frequencies up to 100kHz can be achieved. With Pin 10 at V $^-$, the f_{CLK} to f_{-3dB} ratio is 100:1, the filter has a transitional Butterworth-Cauer response with lower noise and lower delay nonlinearity than the Cauer response. The stopband attenuation at $2.5 \times f_{-3dB}$ is 92dB. Cutoff frequencies up to 50kHz can be achieved.

The LTC1064-4 features low noise and low harmonic distortion even when input voltages up to $3V_{RMS}$ are applied. The LTC1064-4 overall performance competes with equivalent multiple op amp active realizations. The LTC1064-4 is pin compatible with the LTC1064-1, LTC1064-2 and LTC1064-3.

The LTC1064-4 is manufactured using Linear Technology's enhanced LTCMOS[™] silicon gate process.

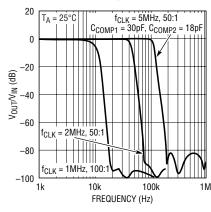
TYPICAL APPLICATION

8th Order Clock Sweepable Lowpass Elliptic Filter



 $^{\circ}$ for frequencies above 20kHz and minimum passband ripple refer to the pin description section for compensation guidelines. Note: the power supplies should be bypassed by a 0.1 μF capacitor close to the package. Bypassing pin 10 with 0.1 μF capacitor reduces clock feedthrough. The connection between pins 7 and 14 should be physically done under the package.

Frequency Response



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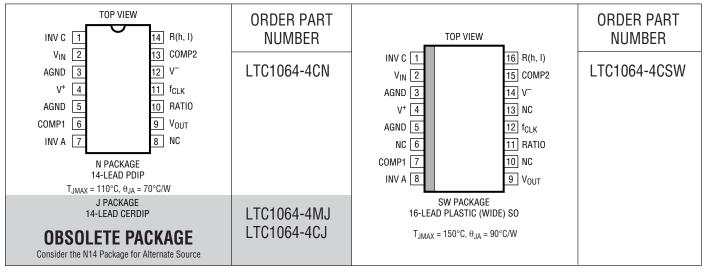
ABSOLUTE MAXIMUM RATINGS (Note 1)

Total Supply Voltage (V+ to V-)	16.5V
Input Voltage at Any Pin V	$-0.3V \le V_{IN} \le V^+ +0.3V$
Power Dissipation	400mW
Storage Temperature Range	–65°C to 150°C

Lead Temperature (Soldering, 10 sec)300°C
Operating Temperature Range
LTC1064-4M (OBSOLETE) – 55°C to 125°C

LTC1064-4C -40°C to 85°C

PACKAGE/ORDER INFORMATION



Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}$ C. $V_S = \pm 7.5$ V, 50:1, $f_{CLK} = 1$ MHz, $f_C = 20$ kHz, R1 = 10k, TTL clock input level unless otherwise specified.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Passband Gain	Referenced to 0dB, 1Hz to 0.05f _{CUTOFF}	•	-0.5		0.1	dB
Gain TempCo				0.0002		dB/°C
Passband Edge Frequency, f _C				$20 \pm 1\%$		kHz
Gain at f _C	Referenced to Passband Gain, f _C = 20kHz	•	-0.4		0.7	dB
-3dB Frequency	50:1 (Cauer Response)			21.5		kHz
	100:1 (Transitional Response)			10		kHz
Passband Ripple (Note 2)	0.1f _C to 0.95f _C Referenced to Passband Gain	•	-0.15		0.6	dB
Stopband Attenuation	At 1.7f _{CUTOFF}	•	-56	-60		dB
Stopband Attenuation	At 2f _{CUTOFF}			-80		dB
Input Frequency Range	50:1, Pin 10 at V ⁺		0		f _{CLK}	kHz
	100:1, Pin 10 at V ⁻		0		f _{CLK} /2	kHz
Output Voltage Swing and	$V_S = \pm 2.37V$	•	±1.1			V
Operating Input Voltage Range	$V_S = \pm 5V$	•	±3.1			V
	$V_S = \pm 7.5V$	•	±5.0			V
Total Harmonic Distortion	$V_S = \pm 5V$, Input = $1V_{RMS}$ at 1kHz			0.015		%
	$V_S = \pm 7.5V$, Input = $3V_{RMS}$ at 1kHz			0.03		%
Wideband Noise	$V_S = \pm 5V$, Input = GND 1Hz to 999kHz			120		μV _{RMS}
	$V_S = \pm 7.5V$, Input = GND 1Hz to 999kHz			135		μV _{RMS}

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ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$. $V_S = \pm 7.5V$, 50:1, $f_{CLK} = 1$ MHz, $f_C = 20$ kHz, R1 = 10k, TTL clock input level unless otherwise specified.

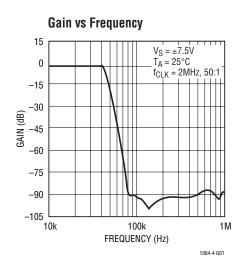
PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Output DC Offset Output DC Offset TempCo	$V_S = \pm 7.5V$ $V_S = \pm 5V$ $V_S = \pm 7.5V$			±50 -100 -200	±160	mV μV/°C μV/°C
Input Impedance			9	13		kΩ
Output Impedance	f _{OUT} = 10kHz			2		Ω
Output Short-Circuit Current	Source/Sink			3/1		mA
Clock Feedthrough	Input = GND			200		μV _{RMS}
Maximum Clock Frequency	$V_S = \pm 7.5V$, 50% Duty Cycle (Note 3)				5	MHz
Power Supply Current	$V_S = \pm 2.37V, f_{CLK} = 1 MHz$ $V_S = \pm 5V, f_{CLK} = 1 MHz$ $V_S = \pm 7.5V, f_{CLK} = 1 MHz$	•		11 14 17	22 23 26 28 32	mA mA mA mA
Power Supply Voltage Range		•	±2.37		±8	V

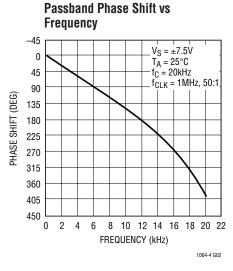
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

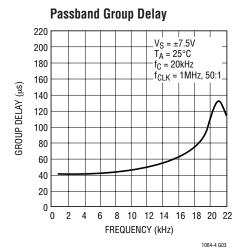
Note 2: For tighter passband ripple specifications please consult with LTC's marketing.

Note 3: Not tested, guaranteed by design.

TYPICAL PERFORMANCE CHARACTERISTICS

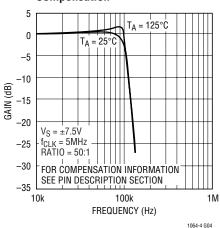




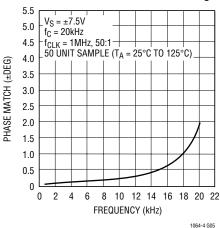


TYPICAL PERFORMANCE CHARACTERISTICS

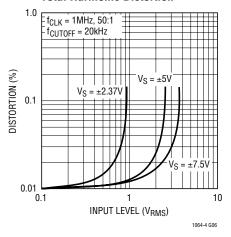
Gain vs Frequency with Compensation



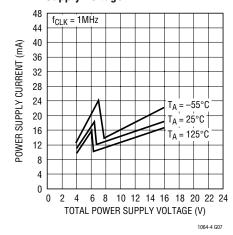
Device to Device Phase Matching



Total Harmonic Distortion



Power Supply Current vs Power Supply Voltage



Transient Response $f_{CLK} = 1MHz$, Ratio = 50:1, $f_{C} = 20kHz$, $V_{S} = \pm 7.5V$, 1kHz

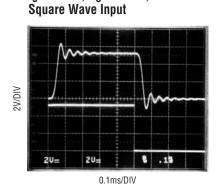


Table 1. Wideband Noise (μV_{RMS}). Input Grounded, $f_{CLK} = 1 MHz$

		V _S = ±2.37V	V _S = ±5V	$V_S = \pm 7.5V$
Pin 10 to	f _{CLK} /f _{CUTOFF}	Noise μ V RMS	Noise μV _{RMS}	Noise µV _{RMS}
V+	50:1	120	135	145
V-	100:1	100	120	130



TYPICAL PERFORMANCE CHARACTERISTICS

Table 2. Gain/Phase, Pin 10 at V+, Typical Response f_{CUTOFF} = 1kHz, $~V_S=\pm5V,~T_A=25^{\circ}C,~f_{CLK}=50\text{kHz},~Ratio}$ = 50:1

	T	
FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	-0.075	-59.990
0.400	-0.050	-122.400
0.600	0.020	169.300
0.800	0.060	88.500
1.000	0.090	-26.100
1.200	-15.640	-175.100
1.400	-34.700	126.500
1.600	-51.700	87.600
1.800	-68.600	38.400
2.000	-84.110	-47.860

Table 3. Gain/Delay, Pin 10 at V+, Typical Response $f_{CUTOFF}=1kHz,\ V_S=\pm5V,\ T_A=25^{\circ}C,\ f_{CLK}=50kHz,\ Ratio=50:1$

FREQUENCY(kHz)	GAIN (dB)	DELAY (ms)
0.200	-0.074	0.844
0.300	-0.070	0.867
0.400	-0.050	0.899
0.500	-0.020	0.949
0.600	0.020	1.021
0.700	0.050	1.122
0.800	0.060	1.275
0.900	0.120	1.592
1.000	0.090	2.160
1.100	-5.020	2.070
1.200	-15.650	1.288

Table 4. Gain/Phase, Pin 10 at V $^-$, Typical Response f $_{-3dB}=$ 1kHz, $~V_S=\pm5V,~T_A=25^{\circ}C,~f_{CLK}=100kHz,~Ratio=100:1$

FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	-0.179	-60.090
0.400	-0.440	-122.000
0.600	-0.810	170.800
0.800	-1.480	91.900
1.000	-3.500	-16.300
1.200	-17.720	-140.500
1.400	-35.700	164.800
1.600	-52.700	135.000
1.800	-71.900	114.000
2.000	-96.160	-49.670

Table 5. Gain/Delay, Pin 10 at V $^-$, Typical Response f $_{-3dB}=$ 1kHz, $~V_S=\pm5V,~T_A=25^{\circ}C,~f_{CLK}=100kHz,~Ratio=100:1$

	•		
FREQ	UENCY(kHz)	GAIN (dB)	DELAY (ms)
	0.200	-0.174	0.842
	0.300	-0.300	0.861
	0.400	-0.440	0.888
	0.500	-0.610	0.933
	0.600	-0.810	0.999
	0.700	-1.090	1.095
	0.800	-1.480	1.242
	0.900	-2.080	1.503
	1.000	-3.500	1.832
	1.100	-8.720	1.724
	1.200	-17.720	1.183

Table 6. Gain/Phase, Pin 10 at GND $V_S=\pm 5V,\, T_A=25^{\circ}C$

FREQUENCY(kHz)	GAIN (dB)	PHASE (deg)
0.200	-0.383	-47.140
0.400	-1.000	-92.000
0.600	-1.300	-134.300
0.800	-0.280	-178.800
1.000	2.670	109.200
1.200	-3.500	6.000
1.400k	-12.510	-47.400
1.600	-20.000	-88.800
1.800	-27.300	-127.800
2.000	-35.000	-164.200

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TYPICAL PERFORMANCE CHARACTERISTICS

Table 7. Gain/Phase for Figure 6. Typical Response, Pin 10 at V+, f_{CUTOFF} = 40kHz, V_S = $\pm 7.5V$, f_{CLK} = 2MHz, Ratio = 50:1

FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
10.000	-0.094	-75.900
12.000	-0.100	-91.400
14.000	-0.090	-107.200
16.000	-0.080	-123.300
18.000	-0.060	-139.600
20.000	-0.040	-156.500
22.000	-0.020	-173.800
24.000	0.000	168.200
26.000	0.020	149.400
28.000	0.030	130.000
30.000	0.020	109.400
32.000	0.010	87.700
34.000	-0.020	64.600
36.000	-0.030	39.500
38.000	-0.010	11.400
40.000	-0.070	-22.000
42.000	-0.920	-64.100
44.000	-4.000	-110.100
46.000	-8.970	-147.000
48.000	-14.320	-173.500
50.000	-19.460	166.800

Table 8. Gain/Phase for Figure 7. Typical Response, Pin 10 at V+, f_{CUTOFF} = 100kHz, V_S = $\pm 7.5V$, T_A = 25°C, f_{CLK} = 5MHz, Ratio = 50:1

FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
10.000	-0.096	-32.390
20.000	-0.100	-64.900
30.000	-0.080	-98.100
40.000	-0.040	-132.300
50.000	0.020	-168.200
60.000	0.070	153.600
70.000	0.040	112.100
80.000	-0.120	66.400
90.000	-0.460	14.600
100.000	-1.310	-49.300
110.000	-5.640	-129.000
120.000	-14.530	167.800
130.000	-23.800	126.700
140.000	-32.600	96.200
150.000	-41.000	71.300
160.000	-49.200	49.200
170.000	-57.500	29.000
180.000	-66.500	9.800
190.000	-77.770	-2.320
200.000	-92.050	76.740

Table 9. Gain/Phase for Figure 7. Typical Response, Pin 10 at V+ f_{CUTOFF} = 100kHz, V_S = $\pm 7.5V$, T_A = 125°C, f_{CLK} = 5MHz, Ratio = 50:1

FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
10.000	-0.071	-33.800
20.000	-0.040	-67.800
30.000	0.050	-102.500
40.000	0.190	-138.300
50.000	0.410	-176.100
60.000	0.670	143.100
70.000	0.920	98.400
80.000	1.150	48.200
90.000	1.530	-10.900
100.000	1.110	-96.500

FREQUENCY (kHz)	GAIN (dB)	PHASE (deg)
110.000	-7.420	172.100
120.000	-18.240	119.400
130.000	-28.000	83.300
140.000	-37.000	54.000
150.000	-45.700	-27.600
160.000	-54.300	2.100
170.000	-63.300	-24.900
180.000	-73.610	-60.210
190.000	-85.300	-138.990
200.000	-83.390	129.580

LINEAR

PIN FUNCTIONS (Pin Numbers Refer to the 14-Pin Package)

INV C, COMP1, INV A, COMP2 (Pins 1, 6, 7 and 13): To obtain a Cauer response with minimum passband ripple and cutoff frequencies above 20kHz, compensating components are required. Figure 6 uses ±7.5V power supplies and compensation components to achieve up to 40kHz *sweepable* cutoff frequencies and ±0.1dB passband ripple. Table 7 lists the typical amplitude response of Figure 6. Figure 7 illustrates the compensation scheme required to obtain a 100kHz cutoff frequency; Graph 4 and Tables 8 and 9 list the typical response of Figure 7 for 25°C and 125°C ambient temperature. As shown the ripple increases at high temperatures but still a ±0.25dB figure can be obtained for ambient temperatures below 70°C.

V_{IN}, **V_{OUT}** (**Pins 2**, **9**): The input Pin 2 is connected to a 12k resistor tied to the inverting input of an op amp. Pin 2 is protected against static discharge. The device's output, Pin 9, is the output of an op amp which can typically source/sink 3mA/1mA. Although the internal op amps are unity gain stable, driving long coax cables is not recommended.

When testing the device for noise and distortion, the output, Pin 9, should be buffered (Figure 4). The op amp power supply wire (or trace) should be connected directly to the power source. To eliminate any output clock feedthrough, Pin 9 should be buffered with a simple R, C lowpass filter (Figure 5). The cutoff frequency of the output filter should be $f_{CLK}/3$.

AGND (Pins 3, 5): For dual supply operation these pins should be connected to a ground plane. For single supply operation both pins should be tied to one half supply (Figure 2).

 V^+ , V^- (Pins 4, 12): Should be bypassed with a 0.1μF capacitor to an adequate analog ground. Low noise, nonswitching power supplies are recommended. *To avoid latchup when the power supplies exhibit high turn-on transients, a 1N5817 Schottky diode should be added from the V⁺ and V⁻ pins to ground (Figures 1 and 2).*

INV A, R(h, I) (Pins 7, 14): A very short connection between Pin 7 and Pin 14 is recommended. This connection should be preferably done under the IC package. In a breadboard, use a one inch, or less, shielded coaxial cable; the shield should be grounded. In a PC board, use a one inch trace or less; surround the trace by a ground plane.

NC (Pin 8): Pin 8 is not internally connected, it should be preferably grounded.

50/100 Ratio (Pin 10): For an f_{CLK}/f_C ratio of 50:1, Pin 10 should be tied to V⁺. For an f_{CLK}/f_{-3dB} ratio of 100:1, Pin 10 should be tied to V⁻. When Pin 10 is at midsupplies (i.e. ground), the filter response is neither Cauer nor transitional. Table 6 illustrates this response. Bypassing Pin 10 with a $0.1\mu F$ capacitor reduces the already small clock feedthrough.



TYPICAL APPLICATIONS

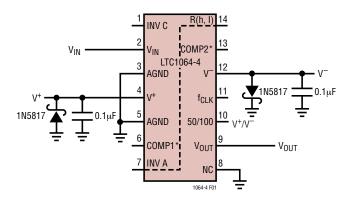


Figure 1. Using Schottky Diodes to Protect the IC from Power Supply Spikes

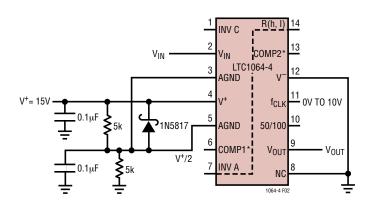


Figure 2. Single Supply Operation. If Fast Power Up or Down Transients are Expected, Use a 1N5817 Schottky Diode Between Pin 4 and Pin 5.

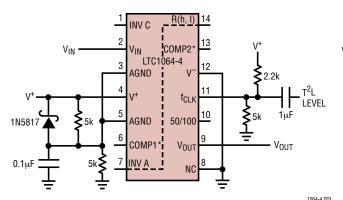


Figure 3. Level Shifting the Input T^2L Clock for Single Supply Operation $\geq 6V$.

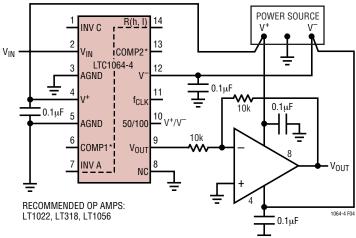


Figure 4. Buffering the Filter Output. The Buffer Op Amp Should Not Share the LTC1064-4 Power Lines.

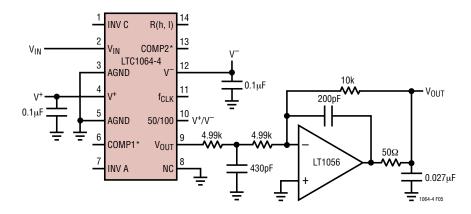
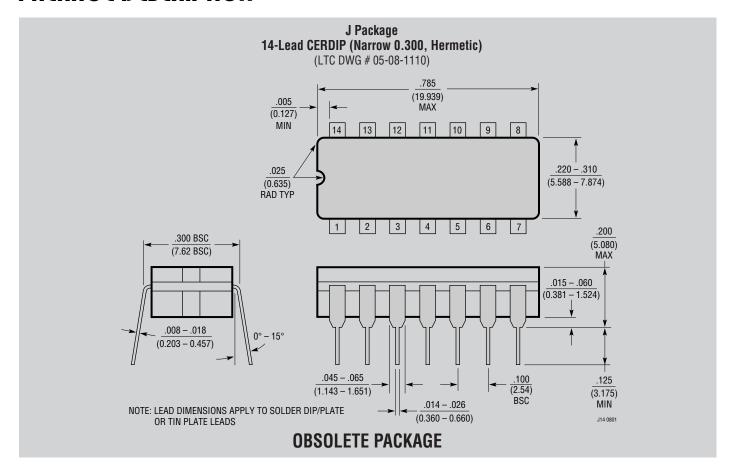


Figure 5. Adding an Output Buffer-Filter to Eliminate Any Clock Feedthrough. Passband Error of Output Buffer is $\pm 0.1 dB$ to 50kHz, -3 dB at 94kHz.

LINEAD TECHNOLOGY

PACKAGE DESCRIPTION

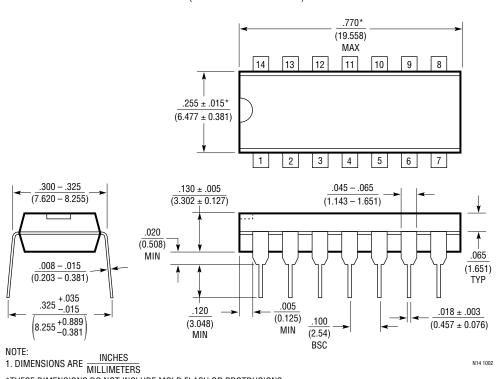




PACKAGE DESCRIPTION

N Package 14-Lead PDIP (Narrow 0.300)

(LTC DWG # 05-08-1510)



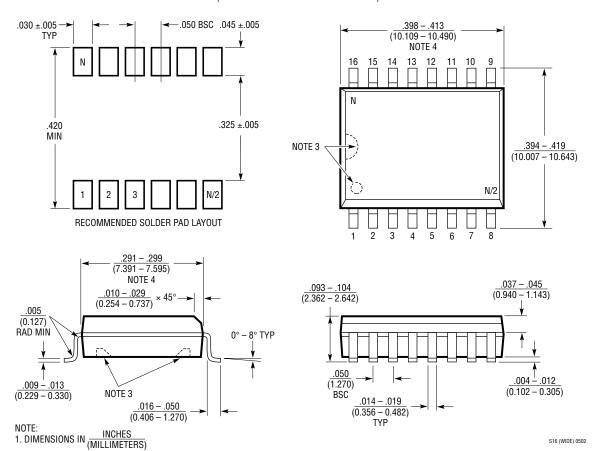
*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .010 INCH (0.254mm)

LINEAR TECHNOLOGY

PACKAGE DESCRIPTION

SW Package 16-Lead Plastic Small Outline (Wide .300 Inch)

(Reference LTC DWG # 05-08-1620)



- 2. DRAWING NOT TO SCALE
- 3. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS
- 4. THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

 MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED .006" (0.15mm)

